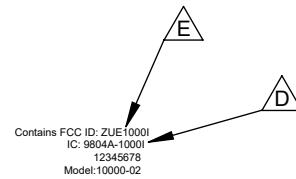


REVISIONS

REV.	DESCRIPTION	DATE	APPROVED
A	Initial Release	2021/11/05	MAG
B	Updated laser etch arrangement to clear alignment pin hole on backbone.	2021/11/29	MAG
C	Updated for new Telink Chip	2022-04-25	AB
D	Fixed error in Telink Chip laser etch	2022-07-19	AB
E	Fixed Error in Telink Chip Laser Etch	2022-08-03	HTA



NOTES:

1. DRAWING DIMENSIONS: refer to 3D CAD file for any dimension not shown on drawing.
2. SIZE: 1mm.
3. FONT: Arial.
4. ROHS: Materials and processes used in manufacture of this part must conform to EU directive 2011/65/EU and all its amending directives at date of purchase order. No substitutions permitted without prior written approval.
5. REACH: Materials and processes used in manufacture of this part must conform to directive 1907/2006 and all its amending directives at date of purchase order. No substitutions permitted without prior written approval.

UNLESS OTHERWISE SPECIFIED:
DIMENSIONS ARE IN MM
TOLERANCES:
ANGULAR: $\pm 0.5^\circ$
SURFACES: 0.5
XX ± 0.5
XX.X ± 0.2
XX.XX ± 0.1

DO NOT SCALE DRAWING
THIRD ANGLE PROJECTION

INFORMATION CONTAINED IN THIS DRAWING IS
PROPRIETARY TO WOW TECH GROUP LTD.
AND SHALL NOT BE DISCLOSED TO ANYONE
OTHER THAN PERSONS AUTHORIZED BY THE
COMPANY TO WHOM W.T. HAS FURNISHED THIS
DRAWING

WOW Tech Group

TITLE
We-Vibe, Vector, Laser Etch

PRODUCT / PROJECT
We-Vibe, Vector

DWG NO.
450-00312

REVISION
E

DESIGNED BY: F. BAETICA

DRAWN BY: V. SLAUNWHITE

CHECKED BY: MICHELLE GODIN

SCALE: 1:1

SHEET SIZE
A

SHEET NUMBER
1 of 1